

SPECIFICATION FOR APPROVAL

CUSTOMER : Mototech Co.

CUSTOMER P/N : _____

DESCRIPTION : PCB ANTENNA + OD1.13 Cable + MHF

A-CON P/N : APP6P-700001

(Preliminary)

Customer Approval

R&D Manager

ACON Approved

<i>Allen 1/4/06</i>	<i>Allen 1/4/06</i>	<i>Mandy 1/19/06</i>	<i>Allen 1/4/06</i>
R&D Manager / Allen.Hsiao	Engineering Manager / Akilis.Chen	Q&R Manager / Mandy.Lee	Project Engineer / Allen.Hsiao



B1, No. 205, Sec.3, Bei-Hsin Rd., Hsin-Tien
Taipei, Taiwan, R.O.C

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Http : //www.acon.com

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Appendix

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1. Description

1.1 Component part number

Assembly : APP6P-700001

1.2 Electrical specification:

Center freq.	2.45 GHz
Bandwidth (VSWR:1.6max)	100MHz
Average gain	-2.1 dBi
Efficiency	50%
Polarization	Linear
Impedance	50 ohm
Size	45.7*19.6 mm ²

2. Electrical Performance

Electrical performance was tested on a typical.

2.1 Return Loss

2.1.1 Setup

Test equipment : VSWR and return loss measurements (S11) were performed using an Agilent 8720ES S-Parameter Network Analyzer and the previously described test fixture.

2.1.2 Results



Frequency (MHz)	S11 (dB)	VSWR
2400	-13.00	1.58
2450	-21.40	1.18
2500	-36.22	1.03

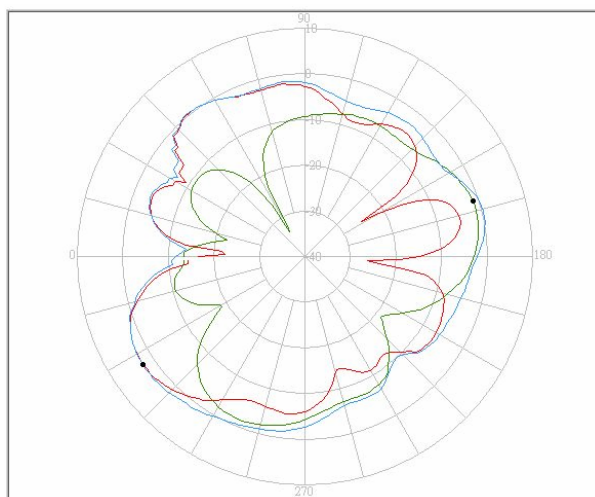
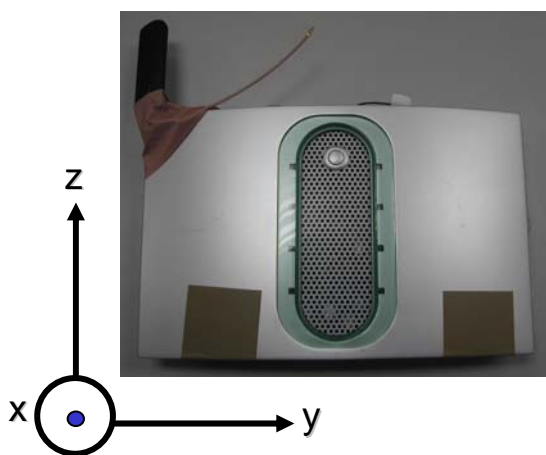
2.2 Gain

2.2.1 Setup

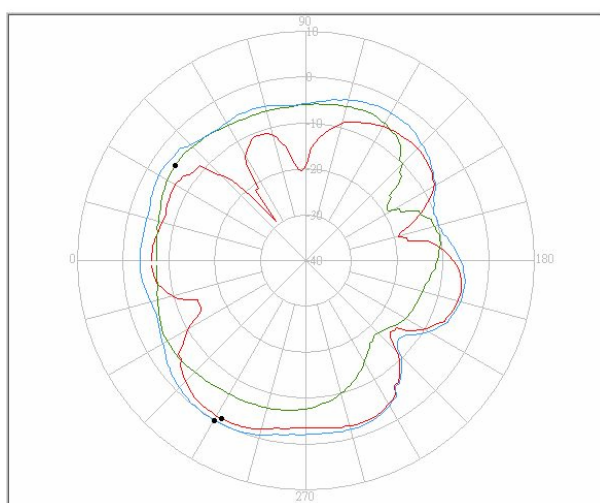
The gain of the antenna measured in the Anechoic Chamber in Hsin-Tien. The chamber provides less than -40dB reflectivity from 400MHz through 6GHz and an 40cm diameter spherical quiet zone. The measurement results are calibrated using both dipoles and standard gain horns. A decoupling sleeve is used to reduce feed line radiation. Only free space tests were performed.

2.2.2 Results

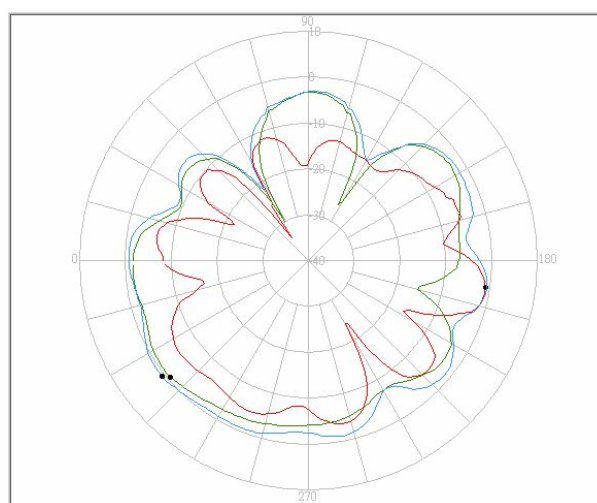
2450MHz



X-Y



X-Z



Y-Z

2.2.2.1 Average antenna gain

H-Plane(X-Y)	Frequency (MHz)	V-Polarization (dBi)	H-Polarization (dBi)	V+H Polarization (dBi)
	2400	-6.65	-4.00	-2.11
	2450	-6.56	-3.94	-2.08
	2500	-5.80	-3.69	-1.61

Table I: Measured the average antenna gain in H-plane including V-polarization, H-polarization and V+H polarization at center frequencies 2400, 2450 and 2500 MHz.

E1-Plane(X-Z)	Frequency (MHz)	V-Polarization (dBi)	H-Polarization (dBi)	V+H Polarization (dBi)
	2400	-6.92	-7.24	-4.06
	2450	-7.45	-7.45	-3.74
	2500	-6.83	-6.83	-2.57

Table II: Measured the average antenna gain in E1-plane including V-polarization, H-polarization and V+H polarization at center frequencies 2400, 2450 and 2500 MHz.

E2-Plane(Y-Z)	Frequency (MHz)	V-Polarization (dBi)	H-Polarization (dBi)	V+H Polarization (dBi)
	2400	-4.36	-7.32	-2.58
	2450	-4.59	-7.64	-2.83
	2500	-4.40	-7.44	-2.65

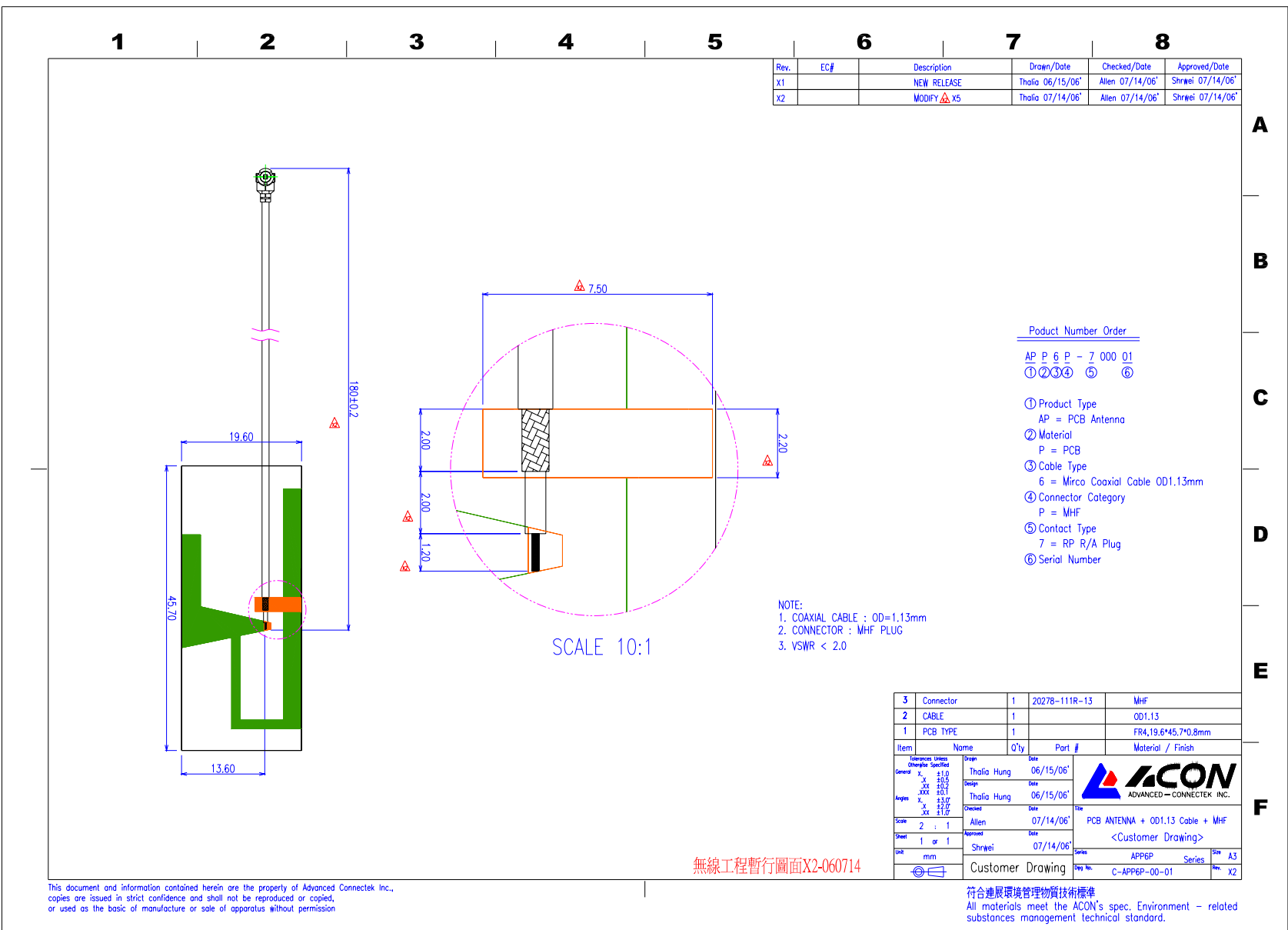
Table III: Measured the average antenna gain in E2-plane including V-polarization, H-polarization and V+H polarization at center frequencies 2400, 2450 and 2500 MHz.

2.2.2.2 Efficiency

Frequency (MHz)	Efficiency (%)
2400	58.61
2450	67.0
2500	56.5

3. Mechanical Specification

3.1 Customer Drawing



Revision History

Revision	Date	Change Notification	Description
Rev.X1	2006/06/22	-	WSFA-06042
Rev.X2	2006/07/14	Revised Drawing	-



TEST REPORT

NUMBER : THJ0019553

APPLICANT: ADVANCED-CONNECTEK INC.
1F NO 2 ALLEY 9 LANE 45 PAO-HSIN ROAD
HSIN-TIEN TAIPEI TAIWAN ROC

DATE : APR 20, 2006

SAMPLE DESCRIPTION:

ONE (1) GROUP OF SUBMITTED SAMPLES SAID TO BE :
SAMPLE DESCRIPTION : PRINTED CIRCUIT BOARD
STYLE / ITEM NO. : COATING TIN
DATE SAMPLE RECEIVED : APR 18, 2006
DATE TEST STARTED : APR 18, 2006

TEST CONDUCTED:

AS REQUESTED BY THE APPLICANT, FOR DETAILS PLEASE REFER TO ATTACHED PAGES.

AUTHORIZED BY:
ON BEHALF OF INTERTEK TESTING SERVICES
TAIWAN LIMITED



JACOB LIN
GENERAL MANAGER

TEST CONDUCTED

(A) TEST RESULT SUMMARY :

TESTING ITEM	RESULT (ppm)
	PCBA
CADMIUM (Cd) CONTENT	ND
LEAD (Pb) CONTENT	33
MERCURY (Hg) CONTENT	ND
CHROMIUM VI (Cr ⁶⁺) CONTENT	ND
PBBs/PBDEs	ND

REMARKS : ppm = PARTS PER MILLION
 ND = NOT DETECTED
 SAMPLES WERE GROUND AND RANDOMLY SELECTED FOR TEST

(B) TEST METHOD :

TESTING ITEM	TESTING METHOD	REPORTING LIMIT
CADMIUM (Cd) CONTENT	WITH REFERENCE TO USEPA 3052, BY MICROWAVE DIGESTION AND DETERMINED BY ICP-OES	2 ppm
LEAD (Pb) CONTENT	WITH REFERENCE TO USEPA 3052, BY MICROWAVE DIGESTION AND DETERMINED BY ICP-OES	2 ppm
MERCURY (Hg) CONTENT	WITH REFERENCE TO USEPA 3052, BY MICROWAVE DIGESTION AND DETERMINED BY ICP-OES	2 ppm
CHROMIUM VI (Cr ⁶⁺) CONTENT	WITH REFERENCE TO USEPA 3060A & 7196A, BY ALKALINE DIGESTION AND DETERMINED BY UV-VIS	1 ppm
PBBs/PBDEs	WITH REFERENCE TO USEPA 3540C, BY SOLVENT EXTRACTION AND DETERMINED BY HPLC-DAD OR GC-MSD	5 ppm

REMARK: REPORTING LIMIT = QUANTITATION LIMIT OF ANALYTE IN SAMPLE

 END OF REPORT

TEST CONDUCTED

PHOTO



Appendix B -- Connector MSDS and SGS

No.2006-1
Sep/30 /'02

材料証明書 MATERIAL CERTIFICATE

当社製品には下記の材料が使われている事を証明致します。

WE HEREBY CERTIFY THAT THE FOLLOWING MATERIALS ARE USED IN OUR PRODUCT.

PRODUCT NAME : MHF series micro coaxial connector PLUG P/N 20278-**1R-**
20308-**1R-**

	部品 COMPONENT	材料/MATERIAL			UL94難燃性 UL94 FLAME CLASS	ULファイルNo. UL FILE No.
		材質名 MATERIAL	型名 CAT No.	材料メーカ MANUFACTURER		
1	HOUSING	PBT	3116	WINTECH POLYMER LTD.	V-0	E 213445

PRODUCT NAME : MHF series micro coaxial connector RECEP. P/N 20279-001E-01

	部品 COMPONENT	材料/MATERIAL			UL94難燃性 UL94 FLAME CLASS	ULファイルNo. UL FILE No.
		材質名 MATERIAL	型名 CAT No.	材料メーカ MANUFACTURER		
1	HOUSING	LCP	E130i	POLYPLASTICS CO.,LTD.	V-0	E 106764

PRODUCT NAME : MHF II connector P/N 20311-**1R-08

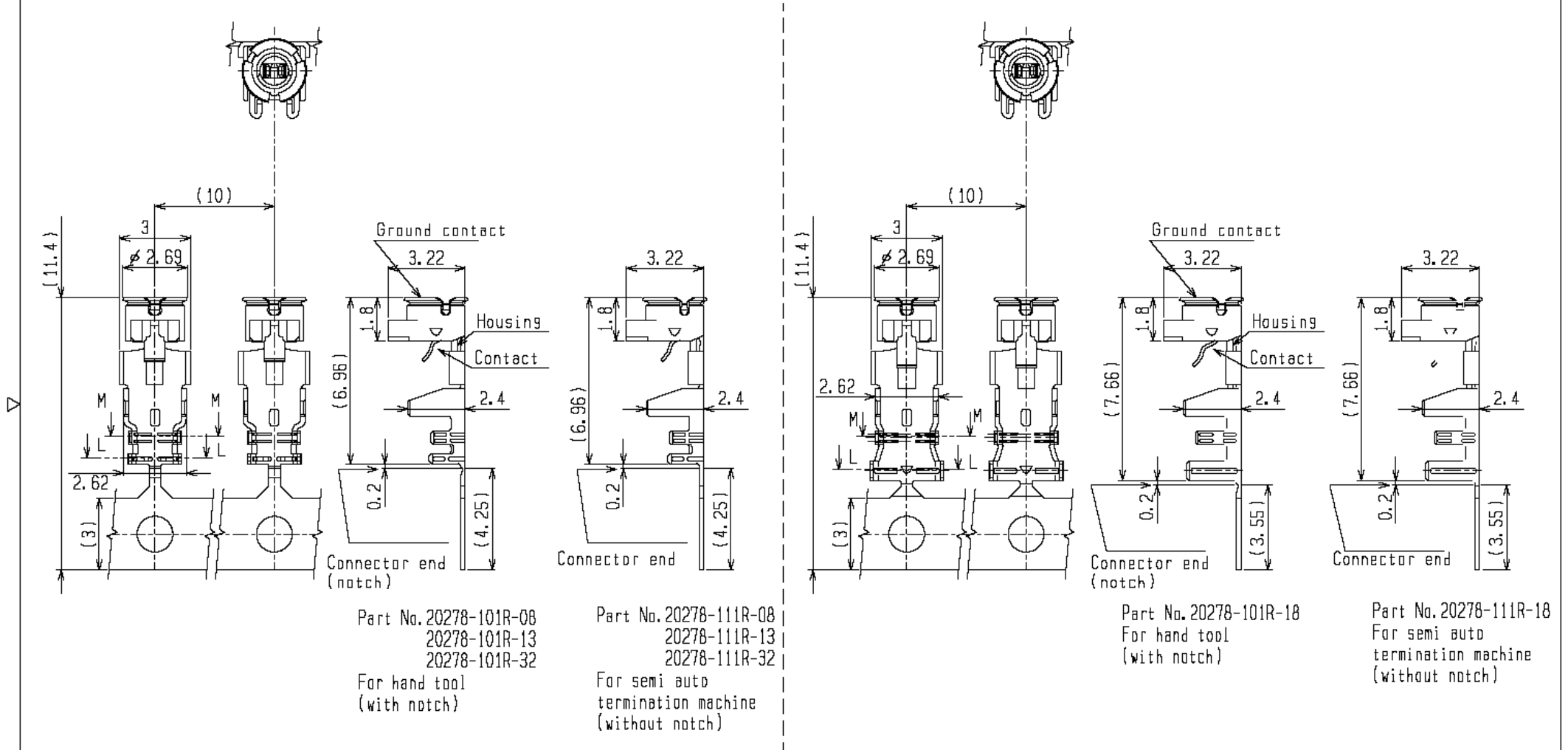
	部品 COMPONENT	材料/MATERIAL			UL94難燃性 UL94 FLAME CLASS	ULファイルNo. UL FILE No.
		材質名 MATERIAL	型名 CAT No.	材料メーカ MANUFACTURER		
1	HOUSING	LCP	A430	POLYPLASTICS CO.,LTD.	V-0	E 106764

株式会社アイペックス
I-PEX Co.,Ltd.

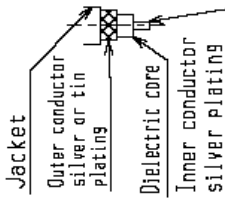
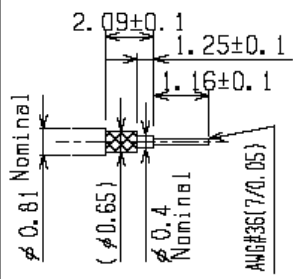
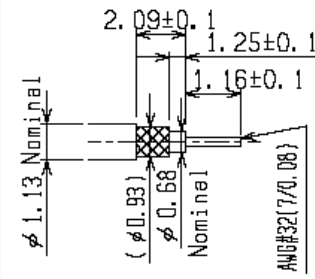
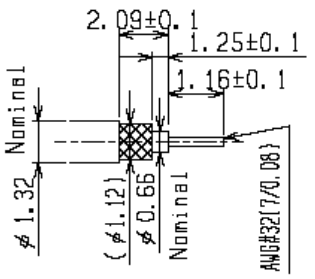
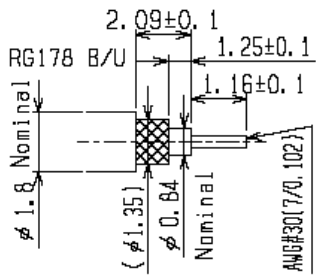
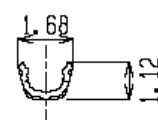
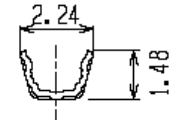
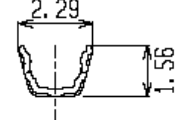
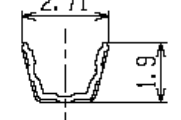
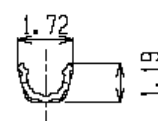
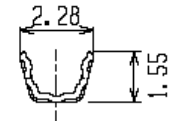
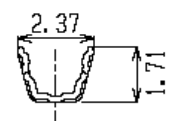
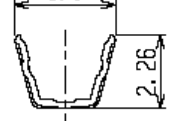
APPROVAL	CHECK	ORIGINATOR
K.Katabuchi Oct/02/'02	E.Kawabe Oct/02/'02	A.Hino Oct/02/'02

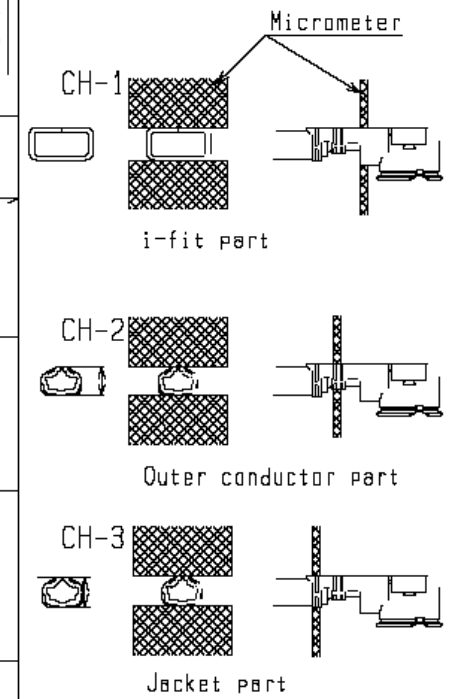
FORM REV.0

PART NO.
20278-**1R-**



GENERAL TDLERANCE		11C	Z3041	K.D	Mar/24/03	K.K	4	Z2023	K.O	JAN/30/02	E.K	DESIGN'D BY	DATE	I-PEX Interconnect and Packaging Electronics TOKYO, JAPAN
6 MAX.	±D. 2	10C	Z3014	K.D	JAN/31/03	K.K	3	Z1256	K.O	NOV/14/01	K.K	K. Ohbayashi	JUN/13/01	
6 OVER MAX. 30	±0. 3	9C	Z2239	K.O	NOV/15/02	E.K	2	Z1197	K.O	AUG/27/01	K.K	CHK'D BY	DATE	TITLE
30 OVER MAX. 120	±0. 5	8C	Z2224	K.D	DCT/17/02	E.K	1	Z1118	K.O	JUN/26/01	K.K	APP'D BY	DATE	MHF series micro coaxial connector plug vertical (ground contact : gold plating)
ANGLE	±2'	7B	Z2180	K.O	JUL/29/02	E.K	0	Z1109	K.O	JUN/13/01	K.K	K. Katabuchi	JUN/13/01	CUSTOMER
REV	ECN	BY	DATE	APP	REV	ECN	BY	DATE	APP	REV	ECN	BY	DATE	PROJECTION
														SCALE
														UNIT
														DWG. No.
														20278
														SHEET
														REV.
														1/3 13C

Part No.	20278-101R-08 20278-111R-08	20278-101R-13 20278-111R-13	20278-101R-32 20278-111R-32	20278-101R-18 20278-111R-18	
Applicable cable nominal dimension 					
	※ NOTE-1	※ NOTE-1	※ NOTE-1	※ NOTE-1	
Braided shield of Outer conductor 外部導体の編組	Single / 1重編	Single / 1重編	Double / 2重編	Single / 1重編	
P/N of hand Tool	90187-008C	90187-013C	90187-032C	90233-018	
P/N of semi auto termination machine	90213-008C	90213-013C	90213-032C	90232-018	
Sect. M-M					
Sect. L-L					
Crimp Height	CH-1	1.34~1.40	1.34~1.40	1.34~1.40	1.34~1.40
	CH-2	0.76~0.84	1.06~1.14	1.20~1.30	1.41~1.49
	CH-3	0.85~0.97	1.15~1.35	1.26~1.46	1.70~1.80



Crimp Height

NOTE-1
中心導体, 外部導体への半田コーティング*は不可
Must not use solder coated inner conductor and outer conductor.

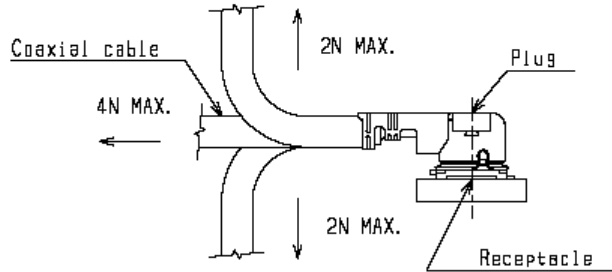
GENERAL TOLERANCE	
6 MAX.	±0.2
6 OVER MAX. 30	±0.3
30 OVER MAX. 120	±0.5
ANGLE	±2'

DESIGN'D BY	DATE	I-PEX Interconnect and Packaging Electronics TOKYO, JAPAN						
CHK'D BY	DATE							
APP'D BY	DATE							
REV. ECN	BY	DATE	APP	TITLE	MHF series micro coaxial connector plus vertical (ground contact : gold plating)			
REV. RECORD				CUSTOMER COPY	PROJECTION	SCALE		
SERIES No.	2814				UNIT	DWG. No.	SHEET	REV.
					mm	20278	2/3	13C

Notes

1. Material
 (1) Housing : PBT , UL94V-0 , black
 (2) Contact
 phosphor bronze
 gold plating 0.1 μ m MIN.
 over nickel 1.27 μ m MIN.
 (3) Ground contact
 phosphor bronze
 gold plating 0.05 μ m MIN.
 over nickel 1.27 μ m MIN.
 2. Packing : reel
 3. Mating partner part No.
 : 20279-001E-01
 4. Permissible load of cable at mating

1. 材料
 (1) ハウジング:PBT, UL94V-0, 黒色
 (2) コンタクト
 引銅
 金メッキ0.1 μ m MIN.
 下地 ニッケル1.27 μ m MIN.
 (3) グランドコンタクト
 引銅
 金メッキ0.05 μ m MIN.
 下地 ニッケル1.27 μ m MIN.
 2. 梱包 : リール
 3. かん合相手 part No.
 : 20279-001E-01
 4. コネクタかん合後のケーブルに対する荷重



5. Suggestions for mating & unmating operation.

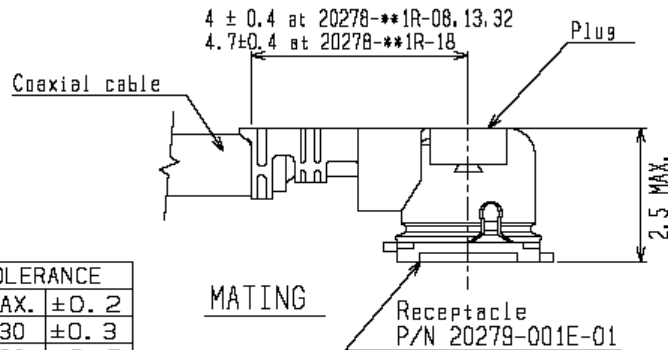
5-1 Mating.

Please mate the connector straightly to vertical direction as much as possible, adjusting the mating axis of plug and receptacle. As excessive slant angle mating may break the connector, please don't do it.

5. コネクタかん合時および抜去時の注意

5-1 コネクタ挿入時

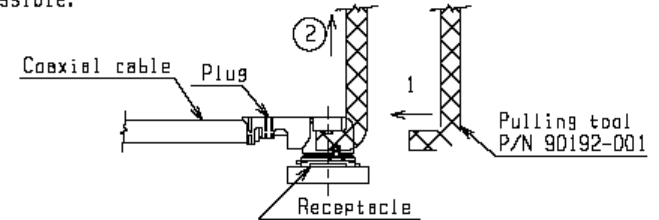
PlugとReceptacleのかん合軸を合わせ、できるだけ垂直に挿入して下さい。極端な斜め挿入は行わないで下さい。コネクタ破損の原因となりますので、過度なこじり挿入は行わないで下さい。



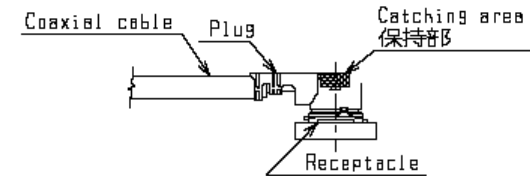
GENERAL TOLERANCE	
6 MAX.	±0.2
6 OVER MAX. 30	±0.3
30 OVER MAX. 120	±0.5
ANGLE	±2°

5-2 Unmating.

- (1) In case of unmating by pulling tool.
 Please use the pulling tool as the following drawing, and please pull plug to vertical direction as directly as possible.



- (2) In case of unmating directly by hand
 Please catch the catching area of plug, and please pull plug to vertical direction as directly as possible.



5-2 コネクタ抜去時

- (1) 抜きジブを用いる場合
 下図のようにできるだけ垂直に引き抜いて下さい。

- (2) 手直接引き抜く場合
 下図の保持部をつかみ、できるだけ垂直に引き抜いて下さい。

5-3 Crimp over standards of outer conductor

Standards: Less than 10% from total numbers of outer conductor
 (Numbers of outer conductor's crimp over from outer conductor's barrel)

5-3 外部導体はみ出し量

外部導体はみ出し量規定 : 外部導体トータル本数の10%以下 (外部導体バレルの外にはみ出した量)

5-4 Caution about Heat shrinkage tubes

Please be careful not to melt housing when using heat shrinkage tubes. It will become cause of open circuit.

5-4 熱収縮チューブについての注意
 熱収縮チューブで外部導体を覆う場合は、導通不良の原因になりますので、熱によりハウジングを溶融させないように注意してください。

				DESIGN'D BY	DATE	I-PEX Interconnect and Packaging Electronics TOKYO, JAPAN	TITLE MHF series micro coaxial connector plug vertical (ground contact : gold plating)				
				CHK'D BY	DATE						
				APP'D BY	DATE						
REV	ECN	BY	DATE	APP	CUSTOMER COPY	PROJECTION	SCALE	UNIT	DWG. No.	SHEET	REV.
SERIES No.				2014			-/-	mm	20278	3/3	13C

Test Report

ADVANCED-CONNECTEK INC.
NO. 2, ALLEY 9, LANE 45, PAO-HSIN RD., HSIN-TIEN,
TAIPEI, TAIWAN, R. O. C.

Report No. : CE/2005/C2056
Date : 2005/12/15
Page : 1 of 4

The following merchandise was (were) submitted and identified by the client as :

Type of Product : MHF SERIES CONNECTORS
Style/Item No : 20278-XXXXR-XX / 20311-XXXXR-XX / 20351-XXXXR-XX /
20367-XXXXR / 20279-001E-01 / 20369-001E
Sample Received : 2005/12/08
Testing Date : 2005/12/08 TO 2005/12/15

=====
Test Result : - Please see the next page -


Daniel Yeh, M.R. / Operation Manager
Signed for and on behalf of
SGS TAIWAN LTD.

Test Report

ADVANCED-CONNECTEK INC.
 NO. 2, ALLEY 9, LANE 45, PAO-HSIN RD., HSIN-TIEN,
 TAIPEI, TAIWAN, R. O. C.

Report No. : CE/2005/C2056
 Date : 2005/12/15
 Page : 2 of 4

Test Result

PART NAME NO.1 : GOLDEN COLORED METAL (SHELL)
 PART NAME NO.2 : BLACK PLASTIC (HOUSING)

Test Item (s):	Unit	Method	MDL	Result	
				No.1	No.2
Monobromobiphenyl	%	With reference to USEPA3540C or USEPA3550C. Analysis was performed by HPLC/DAD, LC/MS or GC/MS. (prohibited by 2002/95/EC (RoHS), 83/264/EEC, and 76/769/EEC)	0.0005	---	N.D.
Dibromobiphenyl	%		0.0005	---	N.D.
Tribromobiphenyl	%		0.0005	---	N.D.
Tetrabromobiphenyl	%		0.0005	---	N.D.
Pentabromobiphenyl	%		0.0005	---	N.D.
Hexabromobiphenyl	%		0.0005	---	N.D.
Heptabromobiphenyl	%		0.0005	---	N.D.
Octabromobiphenyl	%		0.0005	---	N.D.
Nonabromobiphenyl	%		0.0005	---	N.D.
Decabromobiphenyl	%		0.0005	---	N.D.
Total PBBs (Polybrominated biphenyls)/Sum of above	%		-	---	N.D.
Monobromobiphenyl ether	%	With reference to USEPA3540C or USEPA3550C. Analysis was performed by HPLC/DAD, LC/MS or GC/MS. (prohibited by 2002/95/EC (RoHS), 83/264/EEC, and 76/769/EEC)	0.0005	---	N.D.
Dibromobiphenyl ether	%		0.0005	---	N.D.
Tribromobiphenyl ether	%		0.0005	---	N.D.
Tetrabromobiphenyl ether	%		0.0005	---	N.D.
Pentabromobiphenyl ether	%		0.0005	---	N.D.
Hexabromobiphenyl ether	%		0.0005	---	N.D.
Heptabromobiphenyl ether	%		0.0005	---	N.D.
Octabromobiphenyl ether	%		0.0005	---	N.D.
Nonabromobiphenyl ether	%		0.0005	---	N.D.
Decabromobiphenyl ether	%		0.0005	---	N.D.
Total PBBEs(PBDEs) (Polybrominated biphenyl ethers)/Sum of above	%		-	---	N.D.
Total of Mono to Nonabrominated biphenyl ether. (Note 4)	%		-	---	N.D.

Test Report

ADVANCED-CONNECTEK INC.
 NO. 2, ALLEY 9, LANE 45, PAO-HSIN RD., HSIN-TIEN,
 TAIPEI, TAIWAN, R. O. C.

Report No. : CE/2005/C2056
 Date : 2005/12/15
 Page : 3 of 4

Test Item (s):	Unit	Method	MDL	Result	
				No.1	No.2
Chromium VI (Cr+6)	ppm	UV-VIS after reference to US EPA 3060A.	2	N.D.	N.D.
Cadmium (Cd)	ppm	ICP-AES after reference to EN 1122, method B:2001 or other acid digestion.	2	N.D.	N.D.
Mercury (Hg)	ppm	ICP-AES after reference to US EPA 3052 or other acid digestion.	2	N.D.	N.D.
Lead (Pb)	ppm	ICP-AES after reference to US EPA 3050B or other acid digestion.	2	22.0	49.5

- NOTE: (1) N.D. = Not detected (<MDL)
 (2) ppm = mg/kg
 (3) MDL = Method Detection Limit
 (4) Decabromodiphenyl ether (DecaBDE) in polymeric applications is exempted by Commission Decision of 13 Oct 2005 amending Directive 2002/95/EC notified under document 2005/717/EC.
 (5) PBBEs=PBDEs=Polybrominated Diphenyl Ethers=PBDOs=PBBOs.
 (6) " - " = Not Regulation
 (7) " --- " = Not Applicable

Test Report

ADVANCED-CONNECTEK INC.
NO. 2, ALLEY 9, LANE 45, PAO-HSIN RD., HSIN-TIEN,
TAIPEI, TAIWAN, R. O. C.

Report No. : CE/2005/C2056
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